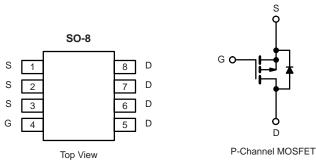


## **IRF7240TRPBF** Datasheet

## P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
- 40	0.010 at $V_{GS}$ = - 10 V	- 16.1	33 nC			
- 40	0.014 at V <sub>GS</sub> = - 4.5 V	- 13.3	33110			



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switch
- POL

Pb-free
RoHS COMPLIANT
HALOGEN

FREE

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 16.1		
Continuous Droin Current (T 150 °C)	T <sub>C</sub> = 70 °C		- 12.9		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 10.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 8.2 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	- 50	A	
Continous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 5.3		
Continous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 28		
Single Pulse Avalanche Energy		E <sub>AS</sub>	39	mJ	
	T <sub>C</sub> = 25 °C		6.3		
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C		4	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
	Symbol	Typical	Maximum	Unit		
t ≤ 10 s	R <sub>thJA</sub>	37	50	°C/W		
Steady State	R <sub>thJF</sub>	16	20	C/ W		
	t ≤ 10 s	Symbol   t ≤ 10 s R <sub>thJA</sub>	SymbolTypical $t \le 10 \text{ s}$ $R_{thJA}$ 37	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		

Notes:

a. Based on  $T_C = 25$  °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

服务热线:400-655-8788

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	Symbol		141111.	Typ.	Widx.	Onic
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 40			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			- 36		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		5		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 1.2	-	- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	1.2		± 100	nA
	-033	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			- 5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 25			А
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10.2 A		0.010		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 8.4 A				Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 10.2 A		37		S
Dynamic <sup>b</sup>						I
Input Capacitance	C <sub>iss</sub>			3007		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		335		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			291		
Total Coto Charge	0	$V_{DS}$ = - 20 V, $V_{GS}$ = - 10 V, $I_D$ = - 10.2 A		64	95	
Total Gate Charge	Q <sub>g</sub>			33	50	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = - 4.5 V, $I_D$ = - 10.2 A		9.8		
Gate-Drain Charge	Q <sub>gd</sub>			15.7		
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			57	86	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2.4 $\Omega$		50	75	- - - -
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 8.2 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		40	60	
Fall Time	t <sub>f</sub>			17	26	
Turn-On Delay Time	t <sub>d(on)</sub>			13	20	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2.4 $\Omega$		11	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\rm I_D \cong$ - 8.2 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 1 $\Omega$		45	68	
Fall Time	t <sub>f</sub>			9	18	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 5.3	А
Pulse Diode Forward Current	I <sub>SM</sub>				- 50	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 8.2 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			36	54	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	— I <sub>F</sub> = - 8.2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		41	62	nC
Reverse Recovery Fall Time	t <sub>a</sub>	F = -0.2  A,  unut = 100  Arps, 1  J = 25  C		20		
Reverse Recovery Rise Time	t <sub>b</sub>			16		ns

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

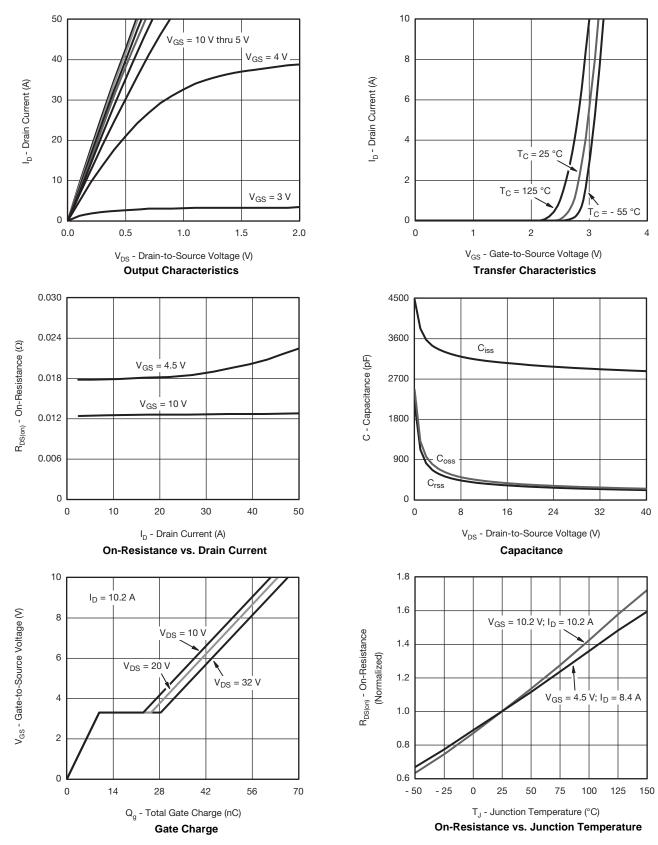
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi

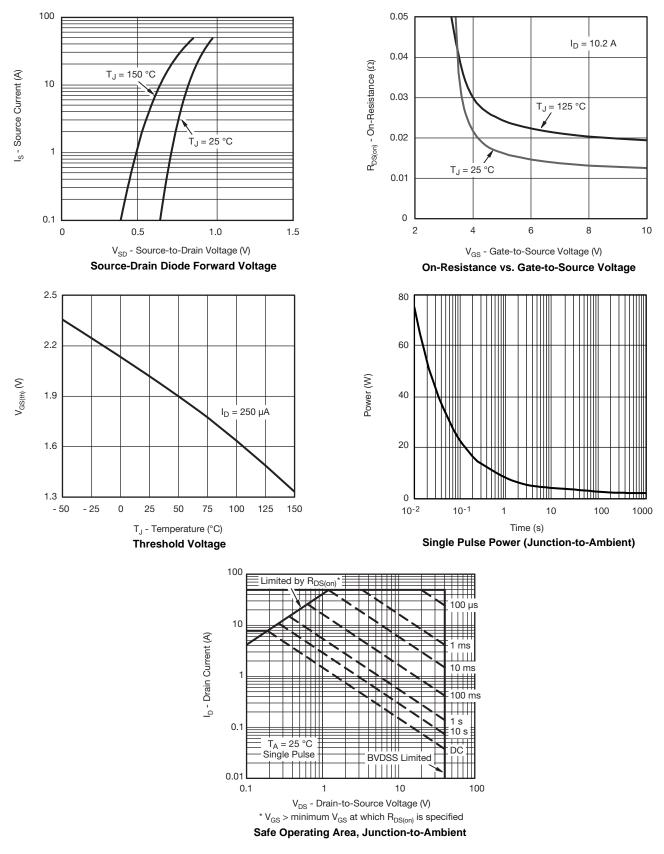
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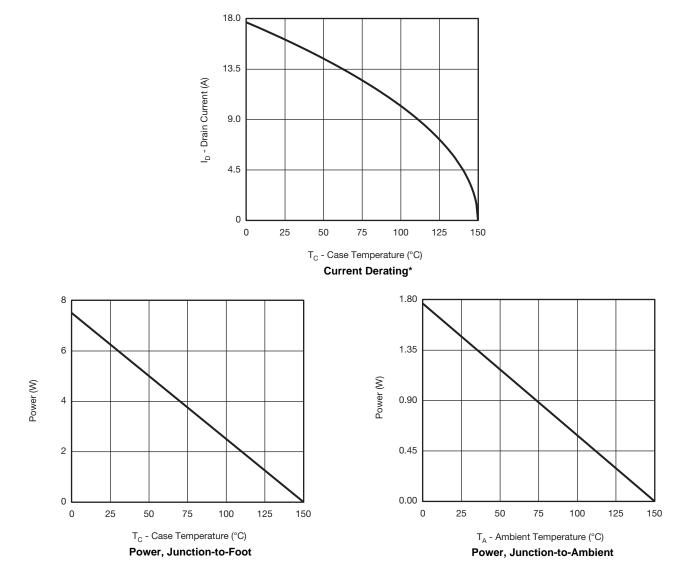




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



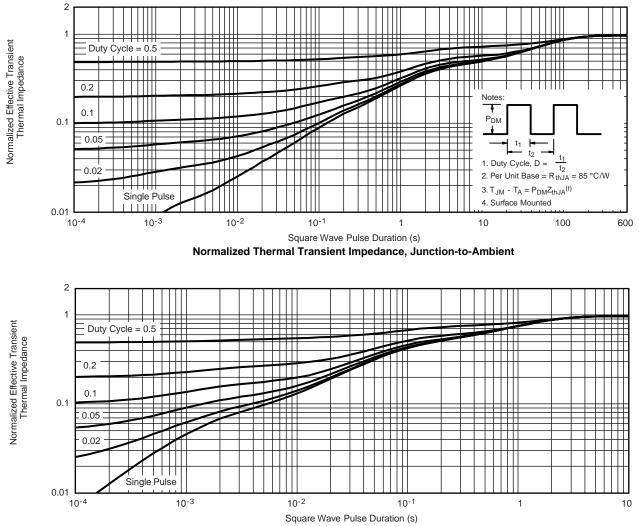
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

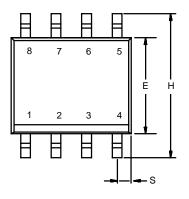


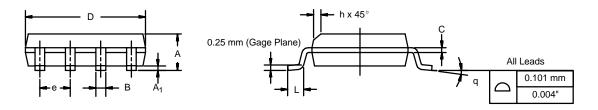
Normalized Thermal Transient Impedance, Junction-to-Foot



### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

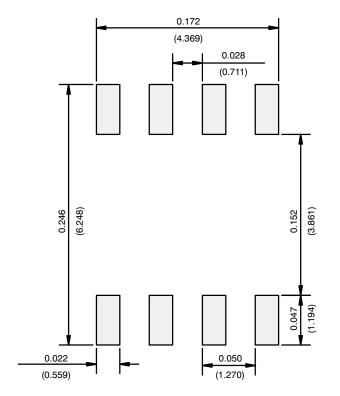




	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
А	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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